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MUR840, MUR860, RURP840, RURP860

Data Sheet November 2013

8 A, 400 V - 600 V, Ultrafast Diodes

Description

The MUR840, MUR860, RURP840, RURP860 is an ultrafast diode with low forward voltage drop. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application.

Ordering Information

PART NUMBER	PACKAGE	BRAND
MUR840	TO-220AC-2L	MUR840
RURP840	TO-220AC-2L	RURP840
MUR860	TO-220AC-2L	MUR860
RURP860	TO-220AC-2L	RURP860

NOTE: When ordering, use the entire part number.

Symbol



Features

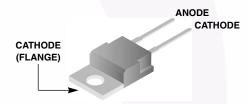
- Ultrafast Recovery $t_{rr} = 70 \text{ ns } (@ I_F = 8 \text{ A})$
- Max Forward Voltage, V_F = 1.5 V (@ T_C = 25°C)
- 400 V, 600 V Reverse Voltage and High Reliability
- · Avalanche Energy Rated
- RoHS Compliant

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Packaging

JEDEC TO-220AC



Absolute Maximum Ratings	$T_C = 25^{\circ}$ C, Unless Otherwise Specified
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	MUR840 RURP840	MUR860 RURP860	UNIT
Peak Repetitive Reverse Voltage	400	600	V
Working Peak Reverse Voltage	400	600	V
DC Blocking VoltageV _R	400	600	V
Average Rectified Forward Current $I_{F(AV)}$ ($T_C = 155^{\circ}C$)	8	8	Α
Repetitive Peak Surge Current	16	16	Α
Nonrepetitive Peak Surge Current IFSM (Halfwave, 1 Phase, 60Hz)	100	100	Α
Maximum Power Dissipation	75	75	W
Avalanche Energy (See Figures 10 and 11)	20	20	mJ
Operating and Storage Temperature	-65 to 175	-65 to 175	°C
Maximum Lead Temperature for Soldering			
Leads at 0.063 in. (1.6mm) from case for 10s	300	300	οС
Package Body for 10s, see Tech Brief 334T _{PKG}	260	260	οС

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Electrical Specifications $T_C = 25^{\circ}C$, Unless Otherwise Specified

		MUR840, RURP840		MUR860, RURP860				
SYMBOL	TEST CONDITION	MIN	ТҮР	MAX	MIN	TYP	МАХ	UNIT
V _F	I _F = 8 A	-	-	1.3	-	-	1.5	V
	I _F = 8 A, T _C = 150 ^o C	-	-	1.0	-	-	1.2	V
I _R	V _R = 400 V	-	-	100	-	-	-	μА
	V _R = 600 V	-	-	-	-	-	100	μА
	V _R = 400 V, T _C = 150 ^o C	-	-	500	-	-	-	μА
	$V_R = 600 \text{ V}, T_C = 150^{\circ}\text{C}$	-	-	-	-	-	500	μА
t _{rr}	I _F = 1 A, dI _F /dt = 200 A/μs	-	-	60	-	-	60	ns
	I _F = 8 A, dI _F /dt = 200 A/μs	-	-	70	-	-	70	ns
t _a	I _F = 8 A, dI _F /dt = 200 A/μs	-	32	-	-	32	-	ns
t _b	I _F = 8 A, dI _F /dt = 200 A/μs	-	21	-	-	21	-	ns
Q _{rr}	I _F = 8 A, dI _F /dt = 200 A/μs	-	195	-	-	195	-	nC
CJ	V _R = 10 V, I _F = 0 A	-	25	-	-	25	-	pF
$R_{\theta JC}$		-	-	2	-	-	2	°C/W

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

I_R = Instantaneous reverse current.

 T_{rr} = Reverse recovery time (See Figure 9), summation of $t_a + t_b$.

ta = Time to reach peak reverse current (See Figure 9).

 $t_b = \text{Time from peak I}_{RM} \text{ to projected zero crossing of I}_{RM} \text{ based on a straight line from peak I}_{RM} \text{ through 25\% of I}_{RM} \text{ (See Figure 9)}.$

Q_{rr} = Reverse recovery charge.

C_J = Junction Capacitance.

 $R_{\theta JC}$ = Thermal resistance junction to case.

pw = pulse width.

D = duty cycle.

Typical Performance Curves

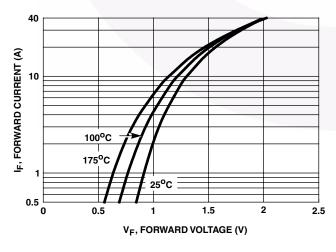


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

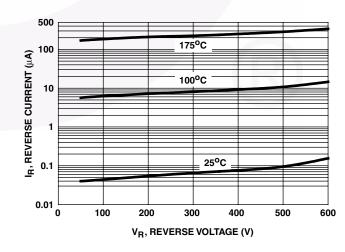


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

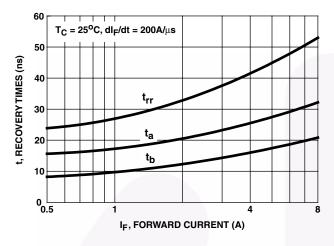


FIGURE 3. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

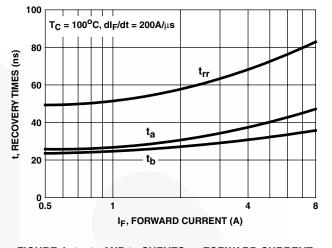


FIGURE 4. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

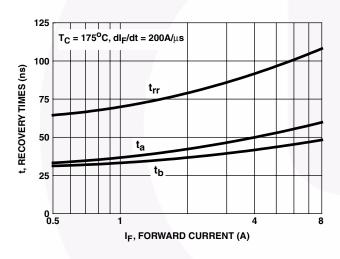


FIGURE 5. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

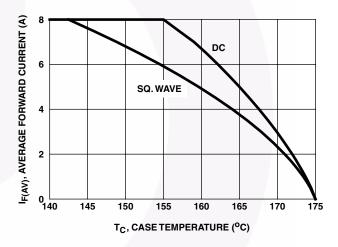


FIGURE 6. CURRENT DERATING CURVE

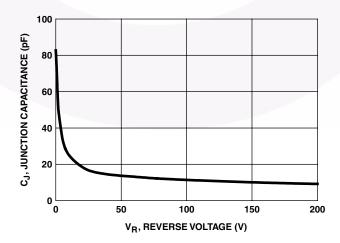


FIGURE 7. JUNCTION CAPACITANCE vs REVERSE VOLTAGE

Test Circuits and Waveforms

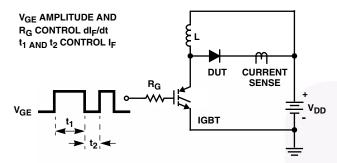


FIGURE 8. t_{rr} TEST CIRCUIT

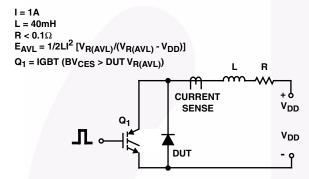


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

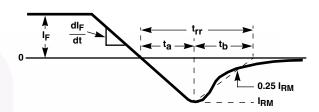


FIGURE 9. t_{rr} WAVEFORMS AND DEFINITIONS

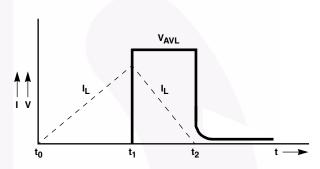


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Mechanical Dimensions

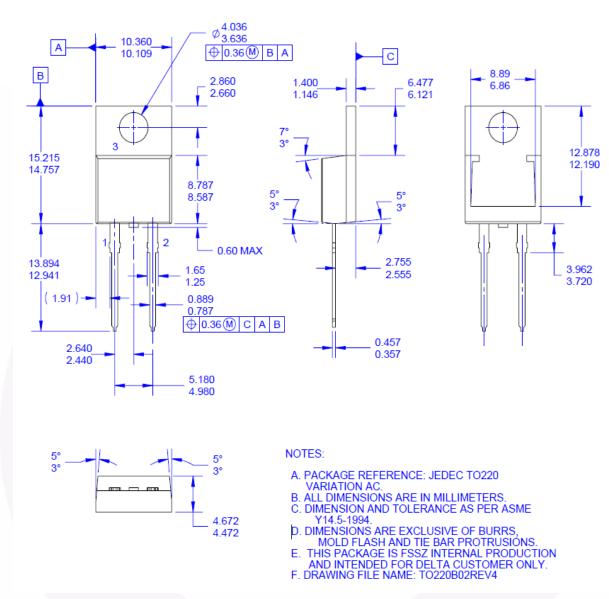


Figure 12. TO-220 2L - TO-220, MOLDED, 2LD

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